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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	6
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 5x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f15313t-i-sn

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4.6.2 LINEAR DATA MEMORY

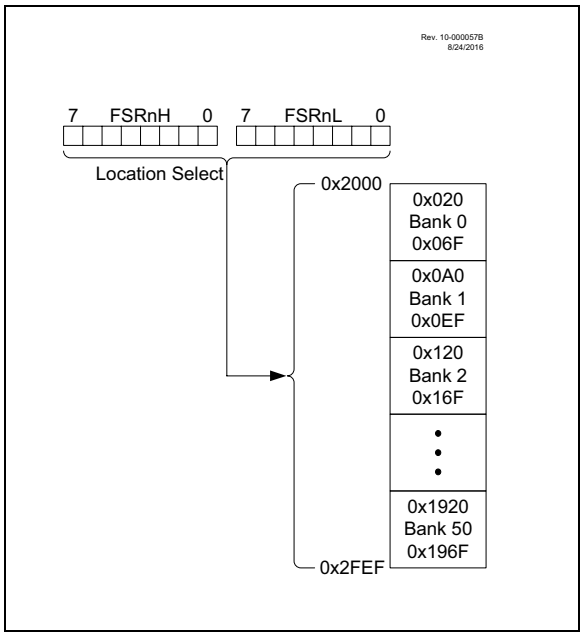
The linear data memory is the region from FSR address 0x2000 to FSR address 0X2FEF. This region is a virtual region that points back to the 80-byte blocks of GPR memory in all the banks. Refer to Figure 4-10 for the Linear Data Memory Map.

Note:	The address range 0x2000 to 0x2FF0 represents the complete addressable Linear Data Memory up to Bank 50. The actual implemented Linear Data Memory will differ from one device to the other in a family. Confirm the memory limits on every device.

Unimplemented memory reads as `0x00`. Use of the linear data memory region allows buffers to be larger than 80 bytes because incrementing the FSR beyond one bank will go directly to the GPR memory of the next bank.

The 16 bytes of common memory are not included in the linear data memory region.

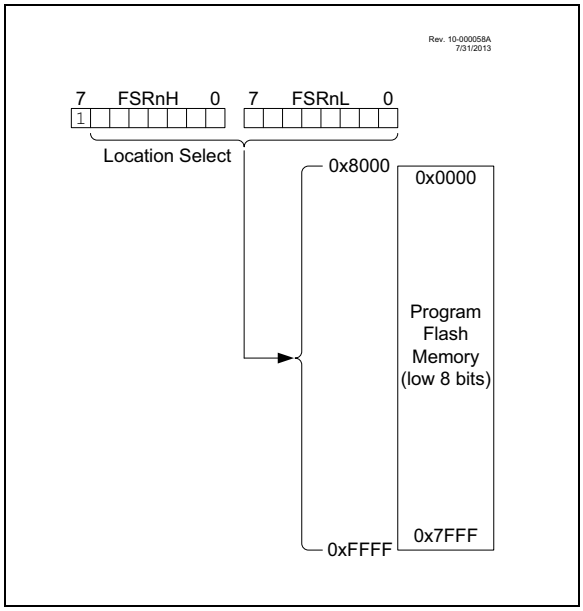
FIGURE 4-10: LINEAR DATA MEMORY MAP



4.6.3 PROGRAM FLASH MEMORY

To make constant data access easier, the entire Program Flash Memory is mapped to the upper half of the FSR address space. When the MSB of FSRnH is set, the lower 15 bits are the address in program memory which will be accessed through INDF. Only the lower eight bits of each memory location is accessible via INDF. Writing to the Program Flash Memory cannot be accomplished via the FSR/INDF interface. All instructions that access Program Flash Memory via the FSR/INDF interface will require one additional instruction cycle to complete.

FIGURE 4-11: PROGRAM FLASH MEMORY MAP



5.3 Code Protection

Code protection allows the device to be protected from unauthorized access. Program memory protection and data memory are controlled independently. Internal access to the program memory is unaffected by any code protection setting.

5.3.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the $\overline{CP}$ bit in Configuration Words. When $\overline{CP}$ = 0, external reads and writes of program memory are inhibited and a read will return all '0's. The CPU can continue to read program memory, regardless of the protection bit settings. Self-writing the program memory is dependent upon the write protection setting. See **Section 5.4 "Write Protection"** for more information.

5.4 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as boot loader software, can be protected while allowing other regions of the program memory to be modified.

The $\overline{WRTAPP}$, $\overline{WRTSAF}$, $\overline{WRTB}$, $\overline{WRTC}$ bits in Configuration Words (Register 5-4) define whether the corresponding region of the program memory block is protected or not.

5.5 User ID

Four memory locations (8000h-8003h) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are readable and writable during normal execution. See **Section 13.3.6 "NVMREG Access to Device Information Area, Device Configuration Area, User ID, Device ID and Configuration Words"** for more information on accessing these memory locations. For more information on checksum calculation, see the *"*PIC16(L)F153xx *Memory Programming Specification"* (DS40001838)*.*

TABLE 9-1: NOSC/COSC BIT SETTINGS

NOSC<2:0>/ COSC<2:0>	Clock Source
111	EXTOSC(1)
110	HFINTOSC(2)
101	LFINTOSC
100	Reserved
011	Reserved (operates like NOSC = 110)
010	EXTOSC with 4x PLL(1)
001	HFINTOSC with 2x PLL(1)
000	Reserved (it operates like NOSC = 110)

Note 1: EXTOSC configured by the FEXTOSC bits of Configuration Word 1 (Register 5-1).

2: HFINTOSC settings are configured with the HFFRQ bits of the OSCFRQ register (Register 9-6).

TABLE 9-2: NDIV/CDIV BIT SETTINGS

NDIV<3:0>/ CDIV<3:0>	Clock divider
1111-1010	Reserved
1001	512
1000	256
0111	128
0110	64
0101	32
0100	16
0011	8
0010	4
0001	2
0000	1

REGISTER 9-3: OSCCON3: OSCILLATOR CONTROL REGISTER 3

R/W/HC-0/0	U-0	U-0	R-0/0	R-0/0	U-0	U-0	U-0
CSWHOLD	—	—	ORDY	NOSCR	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **CSWHOLD:** Clock Switch Hold bit
- 1 = Clock switch will hold (with interrupt) when the oscillator selected by NOSC is ready
- 0 = Clock switch may proceed when the oscillator selected by NOSC is ready; if this bit is clear at the time that NOSCR becomes ‘1’, the switch will occur

bit 6-5 **Unimplemented:** Read as ‘0’.

bit 4 **ORDY:** Oscillator Ready bit (read-only)
- 1 = OSCCON1 = OSCCON2; the current system clock is the clock specified by NOSC
- 0 = A clock switch is in progress

bit 3 **NOSCR:** New Oscillator is Ready bit (read-only)
- 1 = A clock switch is in progress and the oscillator selected by NOSC indicates a “ready” condition
- 0 = A clock switch is not in progress, or the NOSC-selected oscillator is not yet ready

bit 2-0 **Unimplemented:** Read as ‘0’

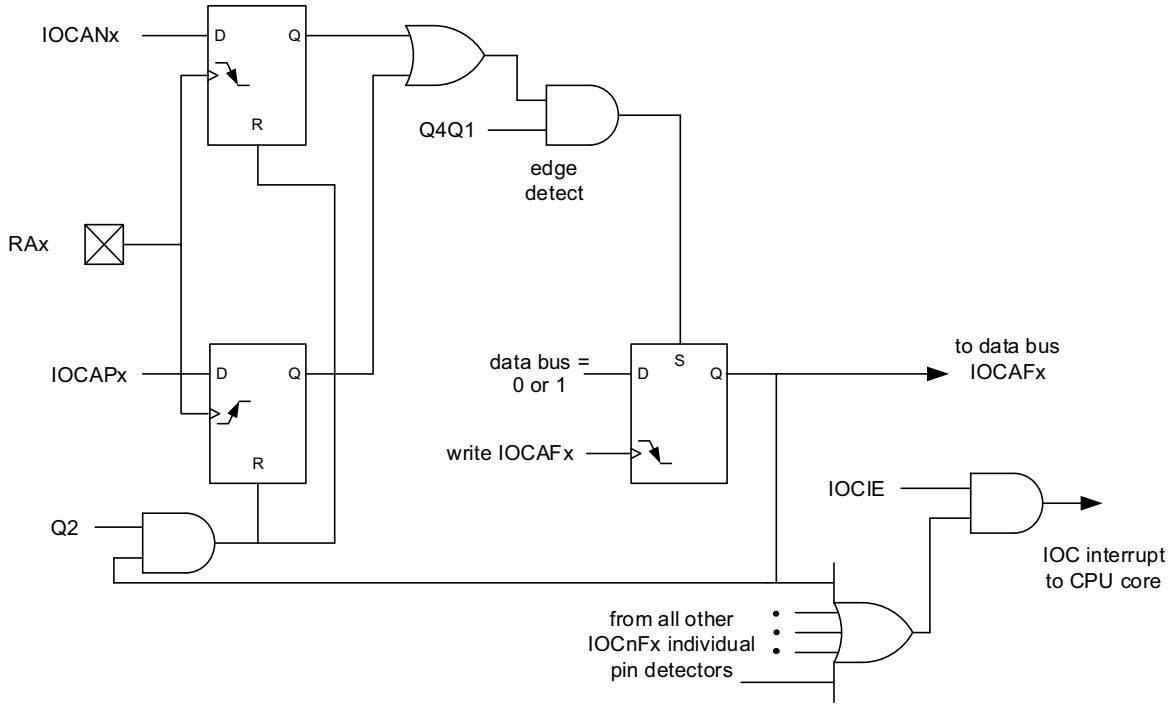
EXAMPLE 13-1: PROGRAM MEMORY READ

```
* This code block will read 1 word of program
* memory at the memory address:
    PROG_ADDR_HI : PROG_ADDR_LO
*   data will be returned in the variables;
*   PROG_DATA_HI, PROG_DATA_LO

    BANKSEL  NVMADRL          ; Select Bank for NVMCON registers
    MOVLW    PROG_ADDR_LO     ;
    MOVWF    NVMADRL          ; Store LSB of address
    MOVLW    PROG_ADDR_HI     ;
    MOVWF    NVMADRH          ; Store MSB of address

    BCF      NVMCON1,NVMREGS  ; Do not select Configuration Space
    BSF      NVMCON1,RD       ; Initiate read

    MOVF     NVMDATL,W        ; Get LSB of word
    MOVWF    PROG_DATA_LO     ; Store in user location
    MOVF     NVMDATH,W        ; Get MSB of word
    MOVWF    PROG_DATA_HI     ; Store in user location
```

EXAMPLE 13-4: WRITING TO PROGRAM FLASH MEMORY

```
; This write routine assumes the following:
; 1. 64 bytes of data are loaded, starting at the address in DATA_ADDR
; 2. Each word of data to be written is made up of two adjacent bytes in DATA_ADDR,
;    stored in little endian format
; 3. A valid starting address (the least significant bits = 00000) is loaded in ADDRH:ADDRL
; 4. ADDRH and ADDRL are located in common RAM (locations 0x70 - 0x7F)
; 5. NVM interrupts are not taken into account

        BANKSEL     NVMADRH
        MOVF        ADDRH,W
        MOVWF       NVMADRH             ; Load initial address
        MOVF        ADDRL,W
        MOVWF       NVMADRL
        MOVLW       LOW DATA_ADDR       ; Load initial data address
        MOVWF       FSR0L
        MOVLW       HIGH DATA_ADDR
        MOVWF       FSR0H
        BCF         NVMCON1,NVMREGS     ; Set Program Flash Memory as write location
        BSF         NVMCON1,WREN        ; Enable writes
        BSF         NVMCON1,LWLO        ; Load only write latches

LOOP
        MOVIW       FSR0++
        MOVWF       NVMDATL             ; Load first data byte
        MOVIW       FSR0++
        MOVWF       NVMDATH             ; Load second data byte

        MOVF        NVMADRL,W
        XORLW       0x1F                ; Check if lower bits of address are 00000
        ANDLW       0x1F                ; and if on last of 32 addresses
        BTFSC       STATUS,Z            ; Last of 32 words?
        GOTO        START_WRITE         ; If so, go write latches into memory

        CALL        UNLOCK_SEQ          ; If not, go load latch
        INCF        NVMADRL,F           ; Increment address
        GOTO        LOOP

START_WRITE
        BCF         NVMCON1,LWLO        ; Latch writes complete, now write memory
        CALL        UNLOCK_SEQ          ; Perform required unlock sequence
        BCF         NVMCON1,WREN        ; Disable writes

UNLOCK_SEQ
        MOVLW       55h
        BCF         INTCON,GIE          ; Disable interrupts
        MOVWF       NVMCON2             ; Begin unlock sequence
        MOVLW       AAh
        MOVWF       NVMCON2
        BSF         NVMCON1,WR
        BSF         INTCON,GIE          ; Unlock sequence complete, re-enable interrupts
        return
```

FIGURE 17-1: INTERRUPT-ON-CHANGE BLOCK DIAGRAM (PORTA EXAMPLE)



Note 1: See Table 8-1 for BOR Active Conditions.

20.3 ADC Acquisition Requirements

For the ADC to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The Analog Input model is shown in Figure 20-4. The source impedance (RS) and the internal sampling switch (RSS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RSS) impedance varies over the device voltage (VDD), refer to Figure 20-4. **The maximum recommended impedance for analog sources is 10 kΩ.** As the source impedance is decreased, the acquisition time may be decreased. After the analog input channel is selected (or changed), an ADC acquisition must be done before the conversion can be started. To calculate the minimum acquisition time, Equation 20-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the ADC). The 1/2 LSb error is the maximum error allowed for the ADC to meet its specified resolution.

EQUATION 20-1: ACQUISITION TIME EXAMPLE

Assumptions: $Temperature = 50°C$ *and external impedance of* $10k\Omega$ *5.0V* V_{DD}

$$T_{ACQ} = \text{Amplifier Settling Time} + \text{Hold Capacitor Charging Time} + \text{Temperature Coefficient}$$
$$= T_{AMP} + T_C + T_{COFF}$$
$$= 2\mu s + T_C + [(\text{Temperature} - 25°C)(0.05\mu s/°C)]$$

The value for T_C *can be approximated with the following equations:*

$$V_{APPLIED}\left(1 - \frac{1}{(2^{n+1}) - 1}\right) = V_{CHOLD} \quad ;[1]\ V_{CHOLD}\ \text{charged to within 1/2 lsb}$$

$$V_{APPLIED}\left(1 - e^{\frac{-T_C}{RC}}\right) = V_{CHOLD} \quad ;[2]\ V_{CHOLD}\ \text{charge response to}\ V_{APPLIED}$$

$$V_{APPLIED}\left(1 - e^{\frac{-T_C}{RC}}\right) = V_{APPLIED}\left(1 - \frac{1}{(2^{n+1}) - 1}\right) \quad ;\text{combining [1] and [2]}$$

Note: Where n = number of bits of the ADC.

Solving for T_C*:*

$$T_C = -C_{HOLD}(R_{IC} + R_{SS} + R_S)\ ln(1/2047)$$
$$= -10pF(1k\Omega + 7k\Omega + 10k\Omega)\ ln(0.0004885)$$
$$= 1.37\mu s$$

Therefore:

$$T_{ACQ} = 2\mu s + 1.37 + [(50°C - 25°C)(0.05\mu s/°C)]$$
$$= 4.62\mu s$$

Note 1: The VAPPLIED has no effect on the equation, since it cancels itself out.

2: The charge holding capacitor (CHOLD) is not discharged after each conversion.

3: The maximum recommended impedance for analog sources is 10 kΩ. This is required to meet the pin leakage specification.

24.0 ZERO-CROSS DETECTION (ZCD) MODULE

The ZCD module detects when an A/C signal crosses through the ground potential. The actual zero crossing threshold is the zero crossing reference voltage, VCPINV, which is typically 0.75V above ground.

The connection to the signal to be detected is through a series current limiting resistor. The module applies a current source or sink to the ZCD pin to maintain a constant voltage on the pin, thereby preventing the pin voltage from forward biasing the ESD protection diodes. When the applied voltage is greater than the reference voltage, the module sinks current. When the applied voltage is less than the reference voltage, the module sources current. The current source and sink action keeps the pin voltage constant over the full range of the applied voltage. The ZCD module is shown in the simplified block diagram Figure 24-2.

The ZCD module is useful when monitoring an A/C waveform for, but not limited to, the following purposes:

- A/C period measurement
- Accurate long term time measurement
- Dimmer phase delayed drive
- Low EMI cycle switching

24.1 External Resistor Selection

The ZCD module requires a current limiting resistor in series with the external voltage source. The impedance and rating of this resistor depends on the external source peak voltage. Select a resistor value that will drop all of the peak voltage when the current through the resistor is nominally 300 μA. Refer to Equation 24-1 and Figure 24-1. Make sure that the ZCD I/O pin internal weak pull-up is disabled so it does not interfere with the current source and sink.

EQUATION 24-1: EXTERNAL RESISTOR

$$R_{SERIES} = \frac{V_{PEAK}}{3 \times 10^{-4}}$$

FIGURE 24-1: EXTERNAL VOLTAGE

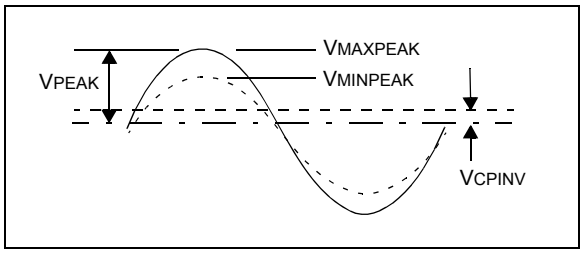


TABLE 25-1: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER0

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
TMR0L	Holding Register for the Least Significant Byte of the 16-bit TMR0 Register								260*
TMR0H	Holding Register for the Most Significant Byte of the 16-bit TMR0 Register								260*
T0CON0	T0EN	—	T0OUT	T016BIT	T0OUTPS<3:0>				263
T0CON1	T0CS<2:0>			T0ASYNC	T0CKPS<3:0>				264
T0CKIPPS	—	—	T0CKIPPS<5:0>						191
TMR0PPS	—	—	TMR0PPS<5:0>						191
T1GCON	GE	GPOL	GTM	GSPM	GGO/$\overline{\text{DONE}}$	GVAL	—	—	275
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	121
PIR0	—	—	TMR0IF	IOCIF	—	—	—	INTF	130
PIE0	—	—	TMR0IE	IOCIE	—	—	—	INTE	122

Legend: — = Unimplemented location, read as '0'. Shaded cells are not used by the Timer0 module.

* Page with Register information.

26.0 TIMER1 MODULE WITH GATE CONTROL

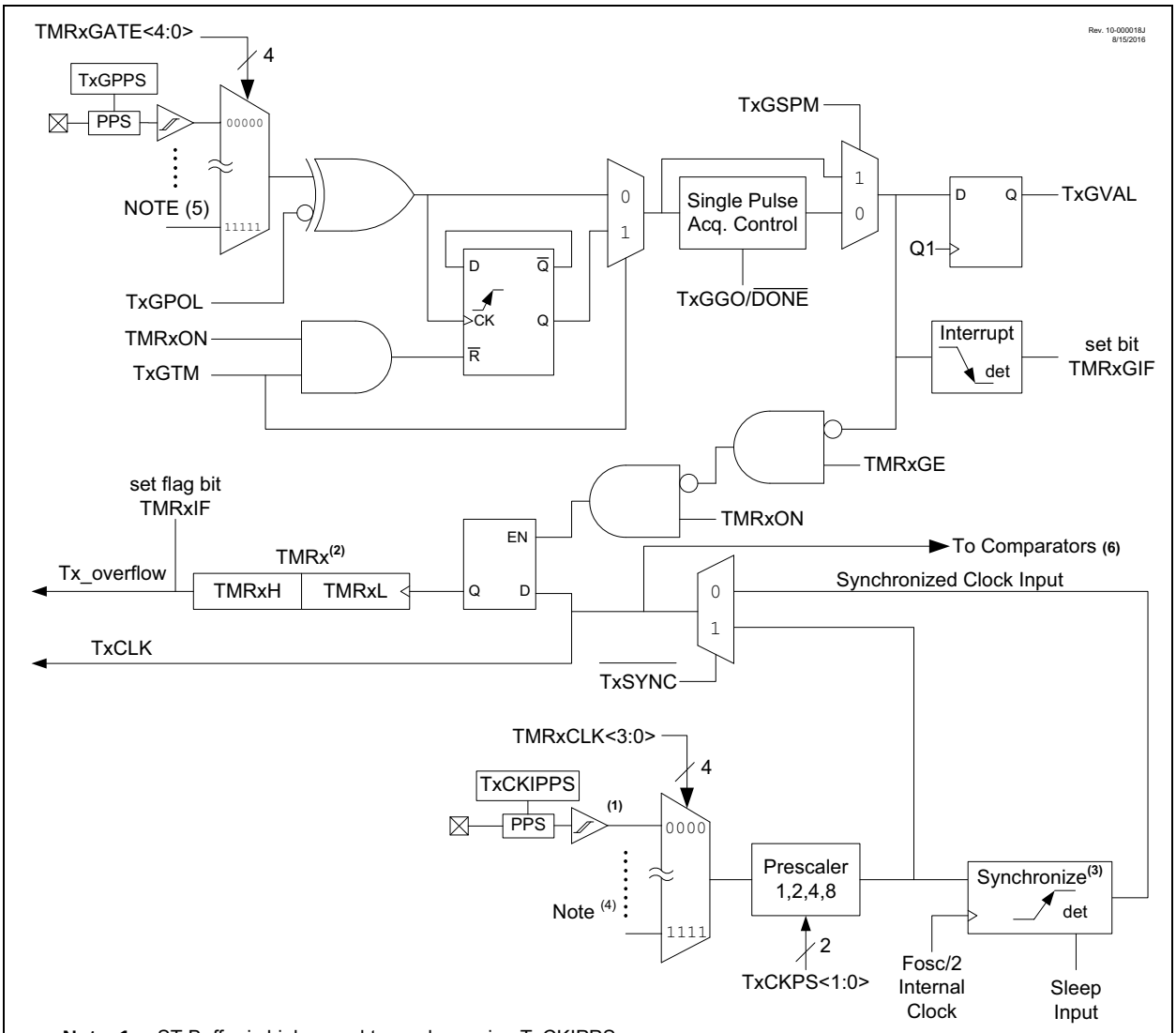
The Timer1 module is 16-bit timer/counters with the following features:

- 16-bit timer/counter register pair (TMR1H:TMR1L)
- Programmable internal or external clock source
- 2-bit prescaler
- Clock source for optional comparator synchronization
- Multiple Timer1 gate (count enable) sources
- Interrupt on overflow
- Wake-up on overflow (external clock, Asynchronous mode only)
- Time base for the Capture/Compare function
- Auto-conversion Trigger (with CCP)
- Selectable Gate Source Polarity
- Gate Toggle mode
- Gate Single-Pulse mode
- Gate Value Status
- Gate Event Interrupt

Figure 26-1 is a block diagram of the Timer1 module.

This device has one instance of Timer1 type modules.

FIGURE 26-1: TIMER1 BLOCK DIAGRAM



Note 1: ST Buffer is high speed type when using TxCKIPPS.

2: TMRx register increments on rising edge.

3: Synchronize does not operate while in Sleep.

4: See Register 26-3 for Clock source selections.

5: See Register 26-4 for GATE source selections.

6: Synchronized comparator output should not be used in conjunction with synchronized input clock.

26.5.2 TIMER GATE SOURCE SELECTION

One of the several different external or internal signal sources may be chosen to gate the timer and allow the timer to increment. The gate input signal source can be selected based on the T1GATE register setting. See the T1GATE register (Register 26-4) description for a complete list of the available gate sources. The polarity for each available source is also selectable. Polarity selection is controlled by the GPOL bit of the T1GCON register.

26.5.2.1 T1G Pin Gate Operation

The T1G pin is one source for the timer gate control. It can be used to supply an external source to the time gate circuitry.

26.5.2.2 Timer0 Overflow Gate Operation

When Timer0 overflows, or a period register match condition occurs (in 8-bit mode), a low-to-high pulse will automatically be generated and internally supplied to the Timer1 gate circuitry.

26.5.2.3 Comparator C1 Gate Operation

The output resulting from a Comparator 1 operation can be selected as a source for the timer gate control. The Comparator 1 output can be synchronized to the timer clock or left asynchronous. For more information see **Section 23.4.1 "Comparator Output Synchronization"**.

26.5.2.4 Comparator C2 Gate Operation

The output resulting from a Comparator 2 operation can be selected as a source for the timer gate control. The Comparator 2 output can be synchronized to the timer clock or left asynchronous. For more information see **Section 23.4.1 "Comparator Output Synchronization"**.

26.5.3 TIMER1 GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a timer gate signal, as opposed to the duration of a single level pulse.

The timer gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 26-4 for timing details.

Timer1 Gate Toggle mode is enabled by setting the GTM bit of the T1GCON register. When the GTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

Note:	Enabling Toggle mode at the same time as changing the gate polarity may result in indeterminate operation.

26.5.4 TIMER1 GATE SINGLE-PULSE MODE

When Timer1 Gate Single-Pulse mode is enabled, it is possible to capture a single-pulse gate event. Timer1 Gate Single-Pulse mode is first enabled by setting the GSPM bit in the T1GCON register. Next, the GGO/$\overline{\text{DONE}}$ bit in the T1GCON register must be set. The timer will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the GGO/$\overline{\text{DONE}}$ bit will automatically be cleared. No other gate events will be allowed to increment the timer until the GGO/$\overline{\text{DONE}}$ bit is once again set in software. See Figure 26-5 for timing details.

If the Single-Pulse Gate mode is disabled by clearing the GSPM bit in the T1GCON register, the GGO/$\overline{\text{DONE}}$ bit should also be cleared.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the timer gate source to be measured. See Figure 26-6 for timing details.

26.5.5 TIMER1 GATE VALUE STATUS

When Timer1 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the GVAL bit in the T1GCON register. The GVAL bit is valid even when the timer gate is not enabled (GE bit is cleared).

26.5.6 TIMER1 GATE EVENT INTERRUPT

When Timer1 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of GVAL occurs, the TMR1GIF flag bit in the PIR5 register will be set. If the TMR1GIE bit in the PIE5 register is set, then an interrupt will be recognized.

The TMR1GIF flag bit operates even when the timer gate is not enabled (TMR1GE bit is cleared).

REGISTER 31-3: CLCxSEL0: GENERIC CLCx DATA 0 SELECT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	LCxD1S<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **LCxD1S<5:0>:** CLCx Data1 Input Selection bits
See Table 31-2.

REGISTER 31-4: CLCxSEL1: GENERIC CLCx DATA 1 SELECT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	LCxD2S<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **LCxD2S<5:0>:** CLCx Data 2 Input Selection bits
See Table 31-2.

REGISTER 31-5: CLCxSEL2: GENERIC CLCx DATA 2 SELECT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	LCxD3S<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **LCxD3S<5:0>:** CLCx Data 3 Input Selection bits
See Table 31-2.

REGISTER 31-6: CLCxSEL3: GENERIC CLCx DATA 3 SELECT REGISTER

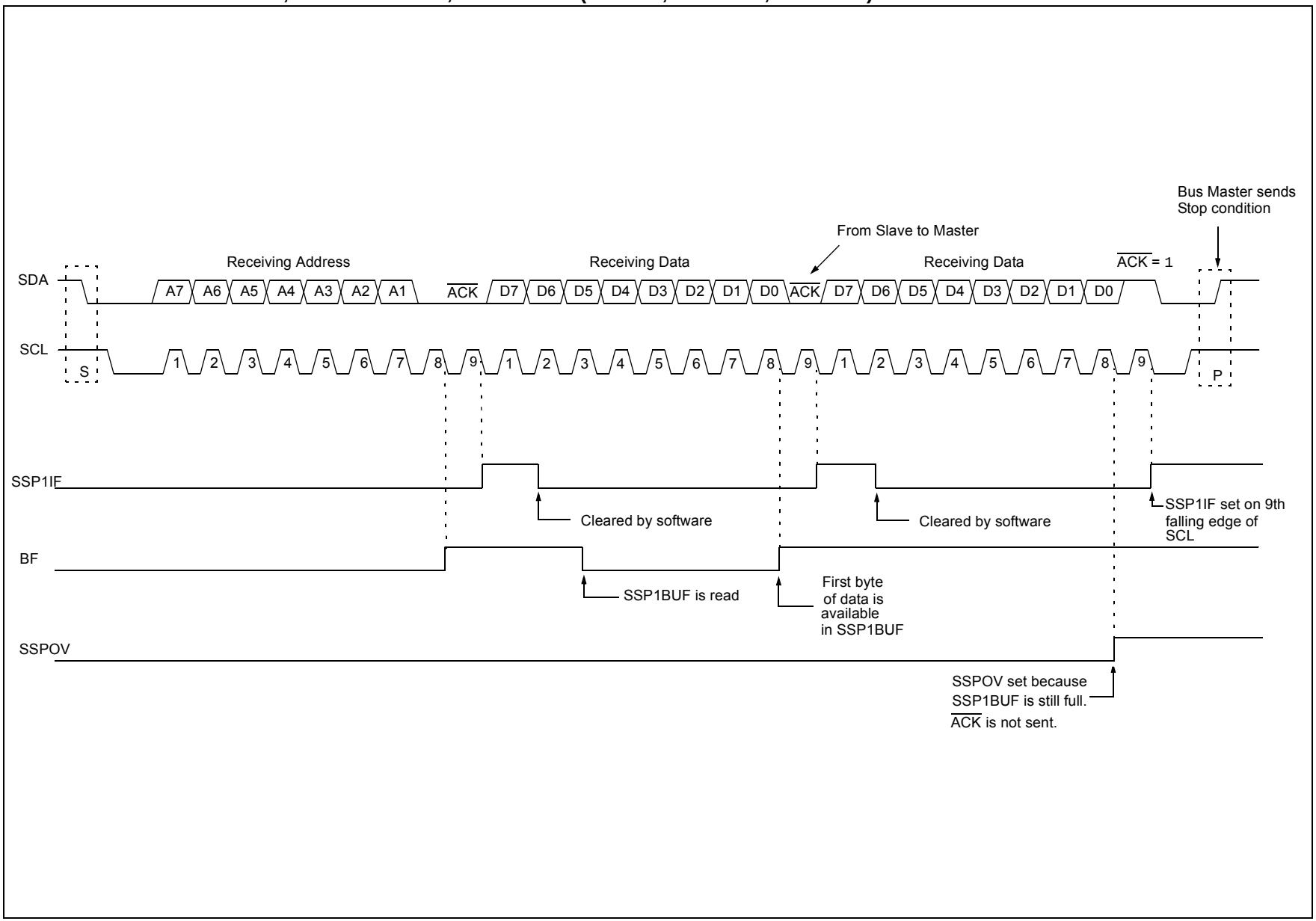
U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	LCxD4S<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **LCxD4S<5:0>:** CLCx Data 4 Input Selection bits
See Table 31-2.

FIGURE 32-14: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 0, AHEN = 0, DHEN = 0)



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REGISTER 32-2: SSP1CON1: SSP1 CONTROL REGISTER 1

R/C/HS-0/0	R/C/HS-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
WCOL	SSPOV(1)	SSPEN	CKP	SSPM<3:0>			
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets	
'1' = Bit is set	'0' = Bit is cleared	HS = Bit is set by hardware	C = User cleared

bit 7 **WCOL:** Write Collision Detect bit (Transmit mode only)
1 = The SSP1BUF register is written while it is still transmitting the previous word (must be cleared in software)
0 = No collision

bit 6 **SSPOV:** Receive Overflow Indicator bit(1)
In SPI mode:
1 = A new byte is received while the SSP1BUF register is still holding the previous data. In case of overflow, the data in SSP1SR is lost. Overflow can only occur in Slave mode. In Slave mode, the user must read the SSP1BUF, even if only transmitting data, to avoid setting overflow. In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSP1BUF register (must be cleared in software).
0 = No overflow
In I^2C mode:
1 = A byte is received while the SSP1BUF register is still holding the previous byte. SSPOV is a "don't care" in Transmit mode (must be cleared in software).
0 = No overflow

bit 5 **SSPEN:** Synchronous Serial Port Enable bit
In both modes, when enabled, the following pins must be properly configured as input or output
In SPI mode:
1 = Enables serial port and configures SCK, SDO, SDI and $\overline{SS}$ as the source of the serial port pins(2)
0 = Disables serial port and configures these pins as I/O port pins
In I^2C mode:
1 = Enables the serial port and configures the SDA and SCL pins as the source of the serial port pins(3)
0 = Disables serial port and configures these pins as I/O port pins

bit 4 **CKP:** Clock Polarity Select bit
In SPI mode:
1 = Idle state for clock is a high level
0 = Idle state for clock is a low level
In I^2C Slave mode:
SCL release control
1 = Enable clock
0 = Holds clock low (clock stretch). (Used to ensure data setup time.)
In I^2C Master mode:
Unused in this mode

bit 3-0 **SSPM<3:0>:** Synchronous Serial Port Mode Select bits
1111 = I^2C Slave mode, 10-bit address with Start and Stop bit interrupts enabled
1110 = I^2C Slave mode, 7-bit address with Start and Stop bit interrupts enabled
1101 = Reserved
1100 = Reserved
1011 = I^2C firmware controlled Master mode (slave idle)
1010 = SPI Master mode, clock = FOSC/(4 * (SSP1ADD+1))(5)
1001 = Reserved
1000 = I^2C Master mode, clock = FOSC / (4 * (SSP1ADD+1))(4)
0111 = I^2C Slave mode, 10-bit address
0110 = I^2C Slave mode, 7-bit address
0101 = SPI Slave mode, clock = SCK pin, $\overline{SS}$ pin control disabled, $\overline{SS}$ can be used as I/O pin
0100 = SPI Slave mode, clock = SCK pin, $\overline{SS}$ pin control enabled
0011 = SPI Master mode, clock = T2_match/2
0010 = SPI Master mode, clock = FOSC/64
0001 = SPI Master mode, clock = FOSC/16
0000 = SPI Master mode, clock = FOSC/4

Note 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSP1BUF register.
2: When enabled, these pins must be properly configured as input or output. Use SSP1SSPPS, SSP1CLKPPS, SSP1DATPPS, and RxyPPS to select the pins.
3: When enabled, the SDA and SCL pins must be configured as inputs. Use SSP1CLKPPS, SSP1DATPPS, and RxyPPS to select the pins.
4: SSP1ADD values of 0, 1 or 2 are not supported for I^2C mode.
5: SSP1ADD value of '0' is not supported. Use SSPM = 0000 instead.

33.1.2.3 Receive Interrupts

The RX1IF interrupt flag bit of the PIR3 register is set whenever the EUSART receiver is enabled and there is an unread character in the receive FIFO. The RX1IF interrupt flag bit is read-only, it cannot be set or cleared by software.

RX1IF interrupts are enabled by setting all of the following bits:

- RX1IE, Interrupt Enable bit of the PIE3 register
- PEIE, Peripheral Interrupt Enable bit of the INTCON register
- GIE, Global Interrupt Enable bit of the INTCON register

The RX1IF interrupt flag bit will be set when there is an unread character in the FIFO, regardless of the state of interrupt enable bits.

33.1.2.4 Receive Framing Error

Each character in the receive FIFO buffer has a corresponding framing error Status bit. A framing error indicates that a Stop bit was not seen at the expected time. The framing error status is accessed via the FERR bit of the RC1STA register. The FERR bit represents the status of the top unread character in the receive FIFO. Therefore, the FERR bit must be read before reading the RC1REG.

The FERR bit is read-only and only applies to the top unread character in the receive FIFO. A framing error (FERR = 1) does not preclude reception of additional characters. It is not necessary to clear the FERR bit. Reading the next character from the FIFO buffer will advance the FIFO to the next character and the next corresponding framing error.

The FERR bit can be forced clear by clearing the SPEN bit of the RC1STA register which resets the EUSART. Clearing the CREN bit of the RC1STA register does not affect the FERR bit. A framing error by itself does not generate an interrupt.

Note:	If all receive characters in the receive FIFO have framing errors, repeated reads of the RC1REG will not clear the FERR bit.

33.1.2.5 Receive Overrun Error

The receive FIFO buffer can hold two characters. An overrun error will be generated if a third character, in its entirety, is received before the FIFO is accessed. When this happens the OERR bit of the RC1STA register is set. The characters already in the FIFO buffer can be read but no additional characters will be received until the error is cleared. The error must be cleared by either clearing the CREN bit of the RC1STA register or by resetting the EUSART by clearing the SPEN bit of the RC1STA register.

33.1.2.6 Receiving 9-Bit Characters

The EUSART supports 9-bit character reception. When the RX9 bit of the RC1STA register is set the EUSART will shift nine bits into the RSR for each character received. The RX9D bit of the RC1STA register is the ninth and Most Significant data bit of the top unread character in the receive FIFO. When reading 9-bit data from the receive FIFO buffer, the RX9D data bit must be read before reading the eight Least Significant bits from the RC1REG.

33.1.2.7 Address Detection

A special Address Detection mode is available for use when multiple receivers share the same transmission line, such as in RS-485 systems. Address detection is enabled by setting the ADDEN bit of the RC1STA register.

Address detection requires 9-bit character reception. When address detection is enabled, only characters with the ninth data bit set will be transferred to the receive FIFO buffer, thereby setting the RX1IF interrupt bit. All other characters will be ignored.

Upon receiving an address character, user software determines if the address matches its own. Upon address match, user software must disable address detection by clearing the ADDEN bit before the next Stop bit occurs. When user software detects the end of the message, determined by the message protocol used, software places the receiver back into the Address Detection mode by setting the ADDEN bit.

FIGURE 33-7: AUTO-WAKE-UP BIT (WUE) TIMING DURING NORMAL OPERATION

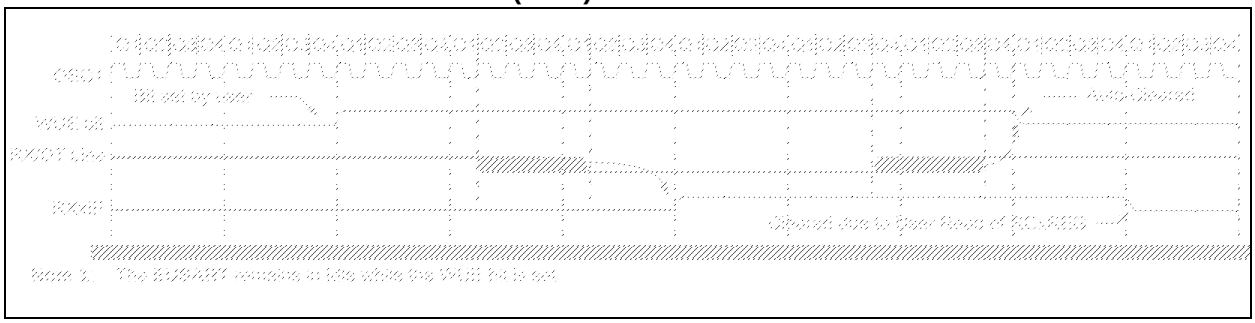
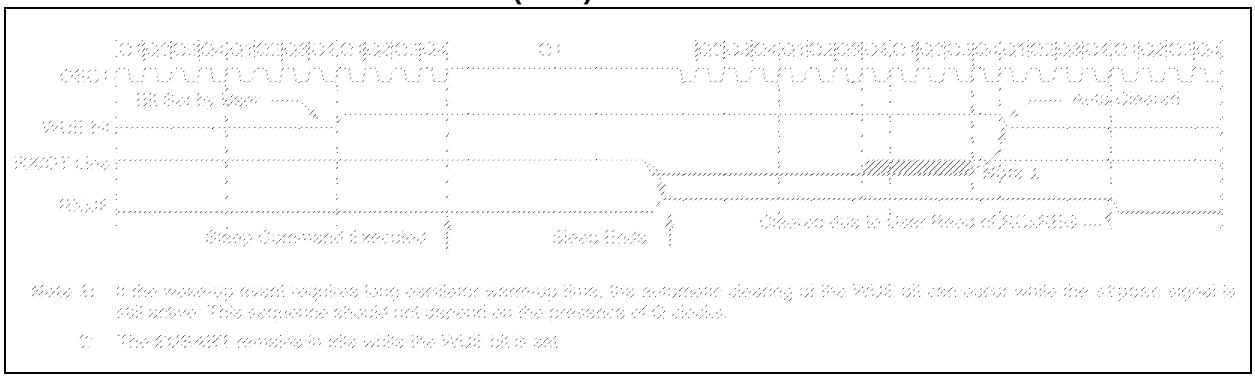


FIGURE 33-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



33.3.4 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN bus standard. A Break character consists of a Start bit, followed by 12 '0' bits and a Stop bit.

To send a Break character, set the SENDB and TXEN bits of the TX1STA register. The Break character transmission is then initiated by a write to the TX1REG. The value of data written to TX1REG will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN specification).

The TRMT bit of the TX1STA register indicates when the transmit operation is active or idle, just as it does during normal transmission. See Figure 33-9 for the timing of the Break character sequence.

33.3.4.1 Break and Sync Transmit Sequence

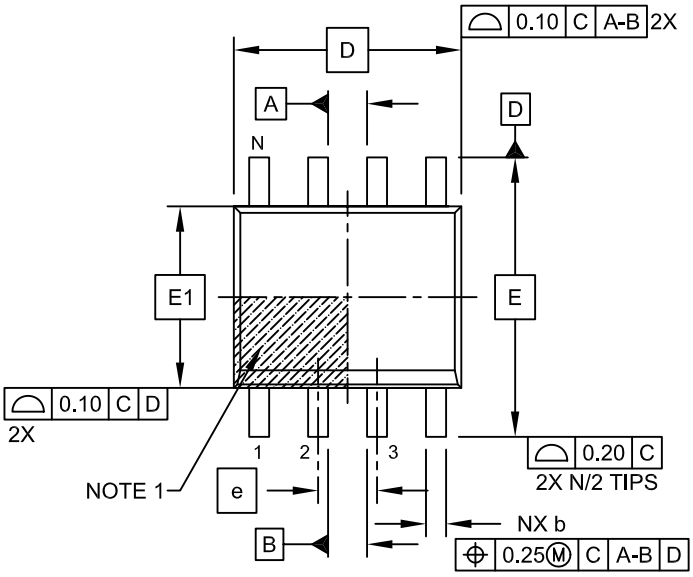
The following sequence will start a message frame header made up of a Break, followed by an auto-baud Sync byte. This sequence is typical of a LIN bus master.

1. Configure the EUSART for the desired mode.
2. Set the TXEN and SENDB bits to enable the Break sequence.
3. Load the TX1REG with a dummy character to initiate transmission (the value is ignored).
4. Write '55h' to TX1REG to load the Sync character into the transmit FIFO buffer.
5. After the Break has been sent, the SENDB bit is reset by hardware and the Sync character is then transmitted.

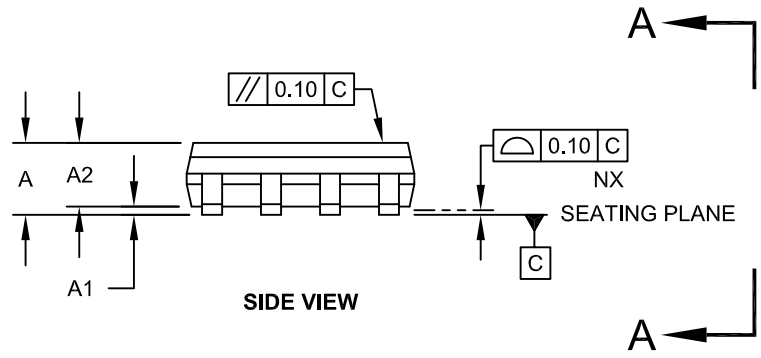
When the TX1REG becomes empty, as indicated by the TX1IF, the next data byte can be written to TX1REG.

8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

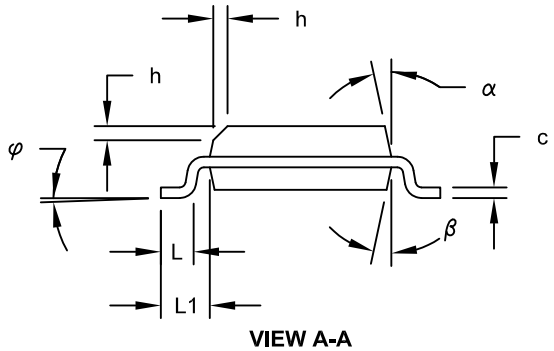
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW

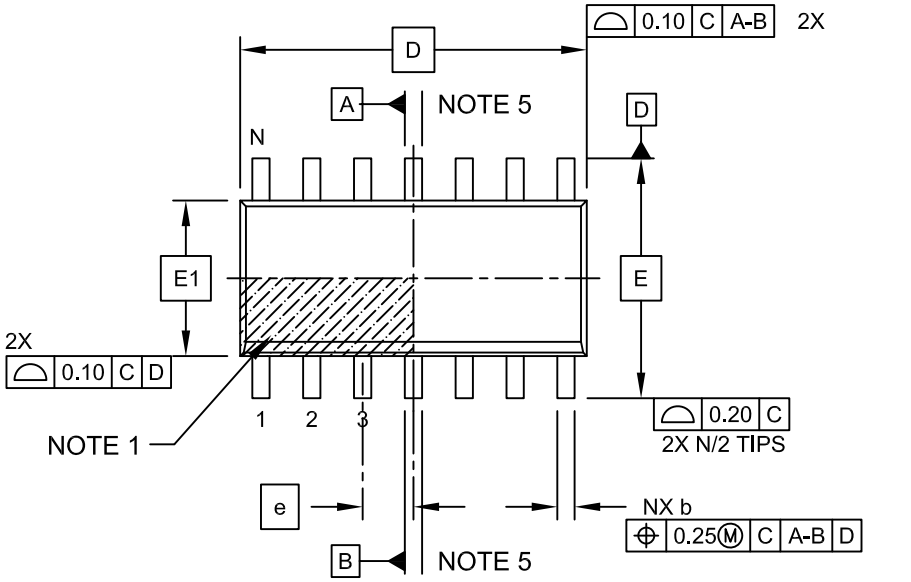


VIEW A-A

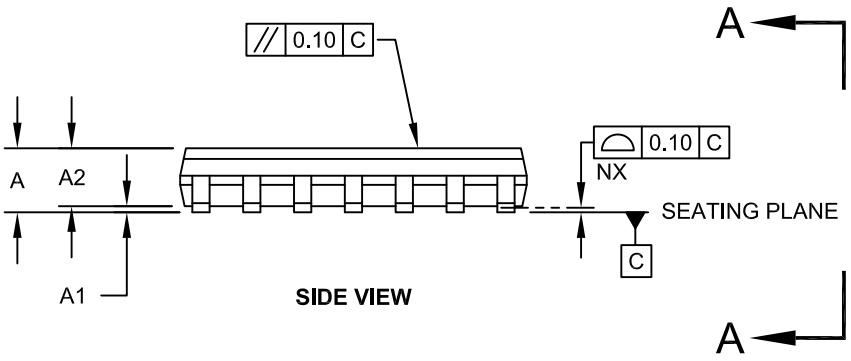
Microchip Technology Drawing No. C04-057C Sheet 1 of 2

14-Lead Plastic Small Outline (SL) - Narrow, 3.90 mm Body [SOIC]

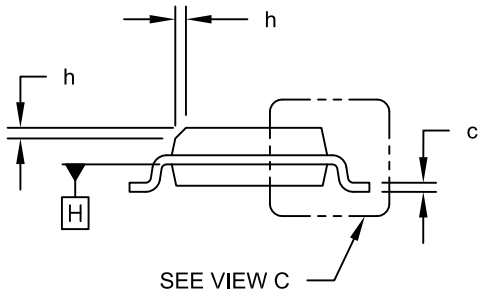
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW

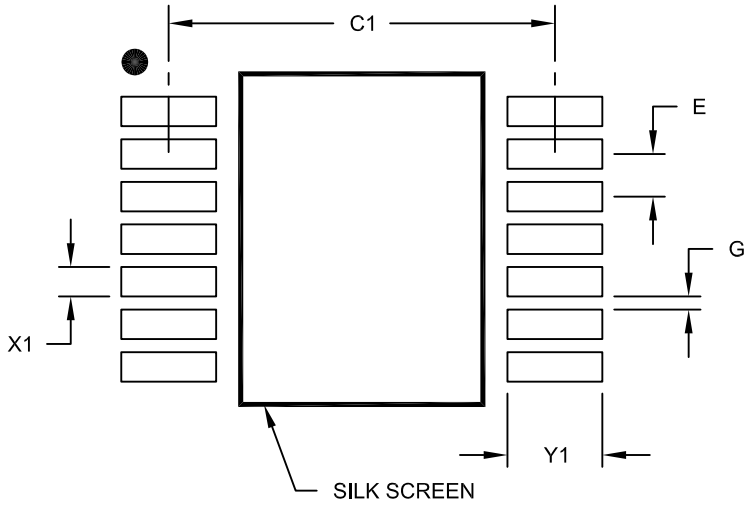


VIEW A-A

Microchip Technology Drawing No. C04-065C Sheet 1 of 2

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Contact Pad Spacing	C1		5.90	
Contact Pad Width (X14)	X1			0.45
Contact Pad Length (X14)	Y1			1.45
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2087A